

## General Description:

Using micro trench design and advanced Field Stop (FS) technology, offering superior conduction and switching performances.

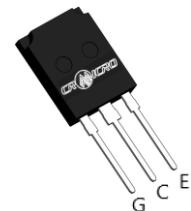
RoHS Compliant.

<b>V<sub>CES</sub></b>	<b>650</b>	<b>V</b>
<b>I<sub>C</sub></b>	<b>120</b>	<b>A</b>
<b>P<sub>tot</sub> (T<sub>C</sub>=25°C)</b>	<b>511</b>	<b>W</b>
<b>V<sub>CE(sat)</sub></b>	<b>1.33</b>	<b>V</b>

## Features:

- FS Trench Technology, Positive temperature coefficient
- Low saturation voltage:  
 $V_{CE(sat)}$ , TYP=1.33V @  $I_C$ =120A,  $V_{GE}$ =15V;
- Low switching loss

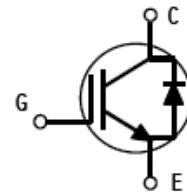
Package:TO-247Plus



## Applications

- UPS
- Solar converts
- Charger

Equivalent circuit:



## Package Parameters

Type	Package	Marking	Packing
CRG120T65AX7HDZ	TO-247Plus	G120T65AX7HDZ	Tube

**Absolute Maximum Ratings** ( $T_C = 25^\circ\text{C}$  unless otherwise specified):

Symbol	Parameter	Rating	Units
$V_{CES}$	Collector-Emitter Voltage	650	V
$V_{GES}$	Gate- Emitter Voltage	$\pm 20$	V
	Gate- Emitter Voltage ( $t_p \leq 10\mu\text{s}, D < 0.01$ )	$\pm 30$	
$I_C^{al}$	Collector Current @ $T_C = 25^\circ\text{C}$	180	A
	Collector Current @ $T_C = 100^\circ\text{C}$	120	
$I_{CM}$	Pulsed Collector Current @ $T_C = 25^\circ\text{C}$	480	A
$I_F^{a2}$	Diode Continuous Forward Current @ $T_C = 25^\circ\text{C}$	180	A
	Diode Continuous Forward Current @ $T_C = 100^\circ\text{C}$	120	
$I_{FM}$	Diode Maximum Forward Current	480	A
$P_D$	Power Dissipation @ $T_C = 25^\circ\text{C}$	511	W
	Power Dissipation @ $T_C = 100^\circ\text{C}$	256	
$T_j^{a3}$	Operating Junction temperature range	-40~175	°C
$T_{stg}$	Storage Temperature Range	-55~150	°C
$T_L$	Maximum Temperature for Soldering	270	°C

**Thermal Characteristics**

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction to case for IGBT	--	0.29	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to case for Diode	--	0.37	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	--	40	°C/W

**Electrical Characteristics of the IGBT** ( $T_C = 25^\circ\text{C}$  unless otherwise specified):

Symbol	Parameter	Test Conditions	SPEC			Units
			Min.	Typ.	Max.	
<b>OFF Characteristics</b>						
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$V_{GE}=0\text{V}, I_{CE}=250\mu\text{A}$	650	--	--	V
$I_{CES}$	Collector-Emitter Leakage Current	$V_{GE}=0\text{V}, V_{CE}=650\text{V}$	--	--	1.0	mA
$I_{GES(F)}$	Gate to Emitter Forward Leakage	$V_{GE}=+20\text{V}$	--	--	+250	nA
$I_{GES(R)}$	Gate to Source Reverse Leakage	$V_{GE}=-20\text{V}$	--	--	-250	nA
<b>ON Characteristics</b>						
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=120\text{A}, V_{GE}=15\text{V}, T_c=25^\circ\text{C}$	--	1.33	1.65	V
		$I_C=120\text{A}, V_{GE}=15\text{V}, T_c=175^\circ\text{C}$	--	1.6	--	V
$V_{GE(th)}$	Gate Threshold Voltage	$I_C=1\text{mA}, V_{CE}=V_{GE}$	3	4	5	V
Pulse width $t_p \leq 300\mu\text{s}, \delta \leq 2\%$						

**Dynamic Characteristics**

$C_{ies}$	Input Capacitance	$V_{CE}=25V, V_{GE}=0V$ $f=100KHz$	--	8726	--	pF
$C_{oes}$	Output Capacitance		--	267	--	
$C_{res}$	Reverse Transfer Capacitance		--	43	--	

**Switching Characteristics**

$t_{d(on)}$	Turn-on Delay Time	$V_{CE}=400V, I_C=120A, R_g=10\Omega, V_{GE}=15V, Inductive Load, T_j=25^\circ C$	--	32	--	ns
$t_r$	Rise Time		--	68	--	
$t_{d(off)}$	Turn-Off Delay Time		--	272	--	
$t_f$	Fall Time		--	79	--	
$E_{on}^{a4}$	Turn-On Switching Loss		--	3.3	--	mJ
$E_{off}$	Turn-Off Switching Loss		--	2.8	--	
$E_{ts}$	Total Switching Loss		--	6.2	--	
$t_{d(on)}$	Turn-on Delay Time		--	36	--	
$t_r$	Rise Time	$V_{CE}=400V, I_C=120A, R_g=10\Omega, V_{GE}=15V, Inductive Load, T_j=175^\circ C$	--	61	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	336	--	
$t_f$	Fall Time		--	62	--	
$E_{on}^{a4}$	Turn-On Switching Loss		--	4.9	--	mJ
$E_{off}$	Turn-Off Switching Loss		--	3	--	
$E_{ts}$	Total Switching Loss		--	7.9	--	
$Q_g$	Total Gate Charge	$V_{CE}=520V, I_C=120A, V_{GE}=15V$	--	414	--	nC
$Q_{ge}$	Gate to Emitter Charge		--	40	--	
$Q_{gc}$	Gate to Collector Charge		--	128	--	

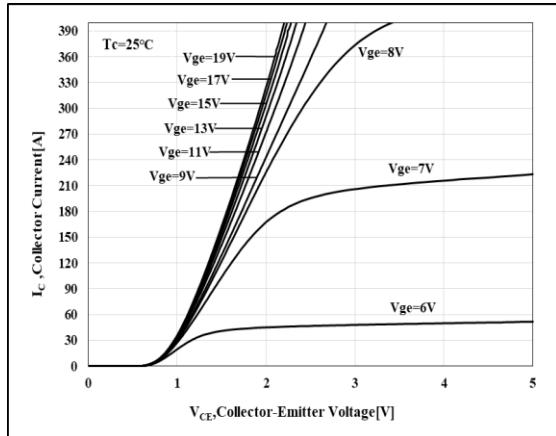
**Electrical Characteristics of the DIODE ( $T_C = 25^\circ C$  unless otherwise specified):**

$V_F$	Diode Forward Voltage	$I_F=120A, T_C=25^\circ C$	--	1.95	2.5	V
		$I_F=120A, T_C=175^\circ C$	--	1.82	--	V
$T_{rr}$	Reverse Recovery Time	$I_F=120A$	--	412	--	ns
$I_{rrm}$	Reverse Recovery Current	$di/dt=200A/Ms$	--	7.82	--	A
$Q_{rr}$	Reverse Recovery Charge	$T_c=25^\circ C$	--	1280	--	nC

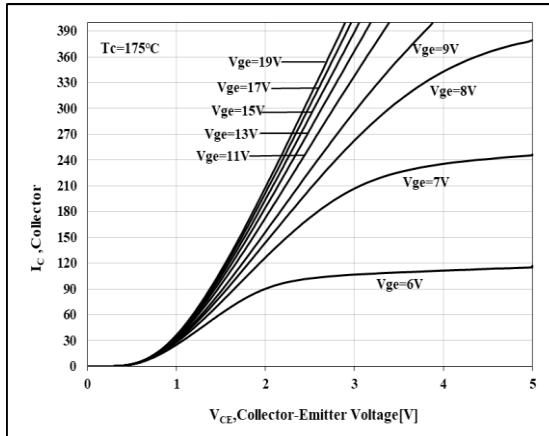
Notes:

- a1: The collector DC current is limited by the maximum junction temperature, limited by the bond wire current capacity at 25 °C
- a2: FRD DC forward current is limited by the maximum junction temperature, limited by the bond wire current capacity at 25 °C
- a3: Repetitive rating; pulse width limited by maximum junction temperature; Under overloading conditions, it is allowed to operate under the maximum junction temperature  $T_{vjop}=175^\circ C$ , and the maximum duty cycle is less than 20% (maximum lasting 60s)
- a4: Turn-on losses include diode losses

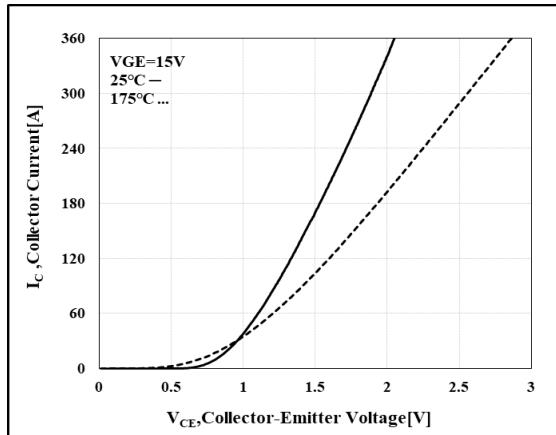
### Typical Performance Characteristics:



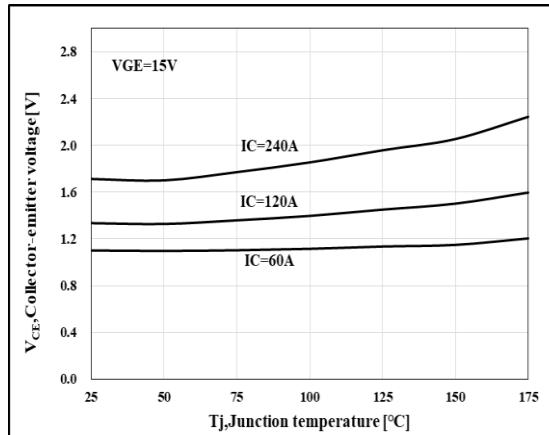
**Figure 1.Output Characteristics**



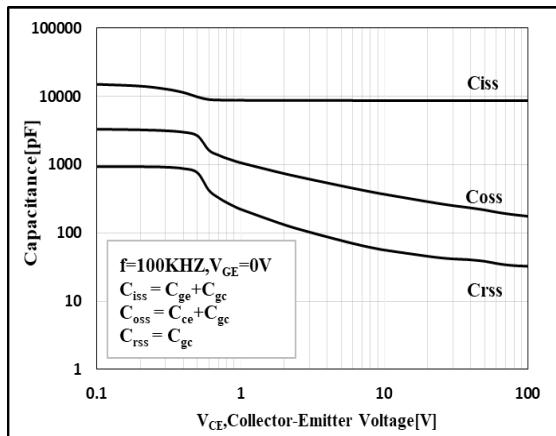
**Figure 2.Output Characteristics**



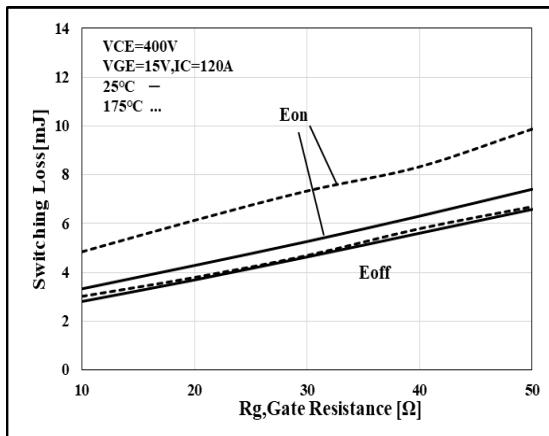
**Figure 3.Saturation Voltage Characteristics**



**Figure 4.Saturation Voltage -Tc Characteristics**



**Figure 5.Capacitance Characteristics**



**Figure 6.Switching Loss-R<sub>G</sub> Characteristics**

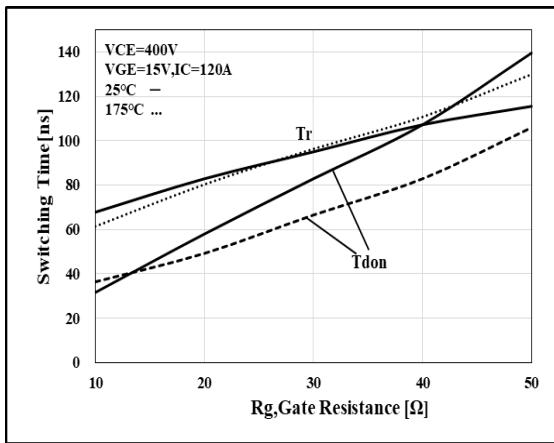


Figure 7.Switching Time-R<sub>G</sub> Characteristics

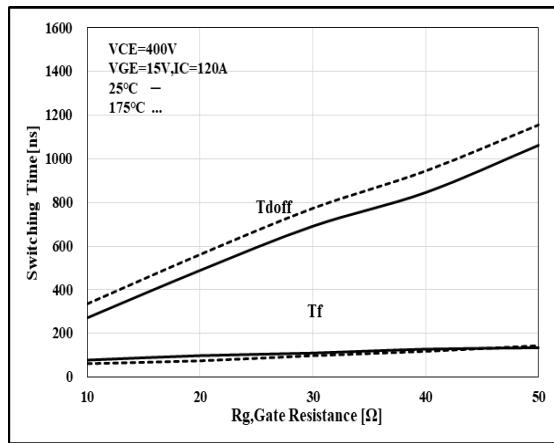


Figure 8.Switching Time-R<sub>G</sub> Characteristics

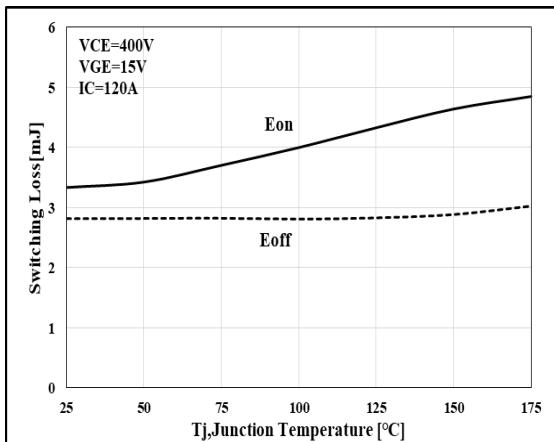


Figure 9.Switching Loss-T<sub>j</sub> Characteristics

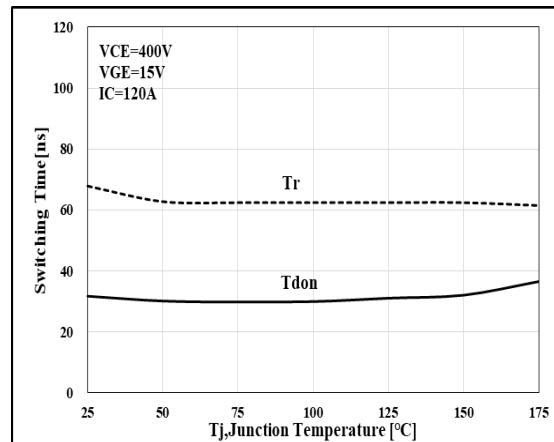


Figure 10.Switching Time-T<sub>j</sub> Characteristics

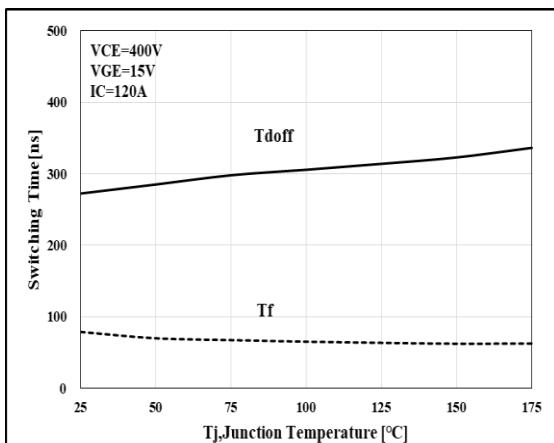


Figure 11.Switching Time-T<sub>j</sub> Characteristics

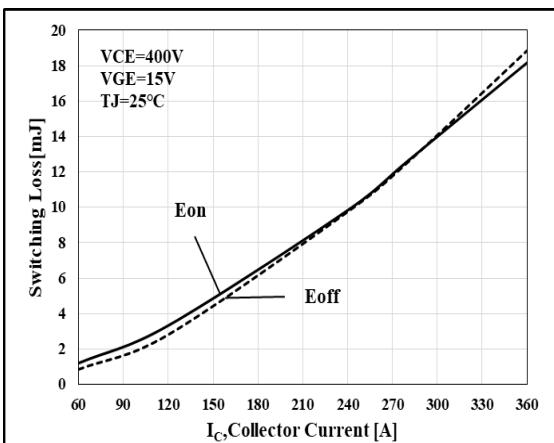


Figure 12.Switching Loss-I<sub>C</sub> Characteristics

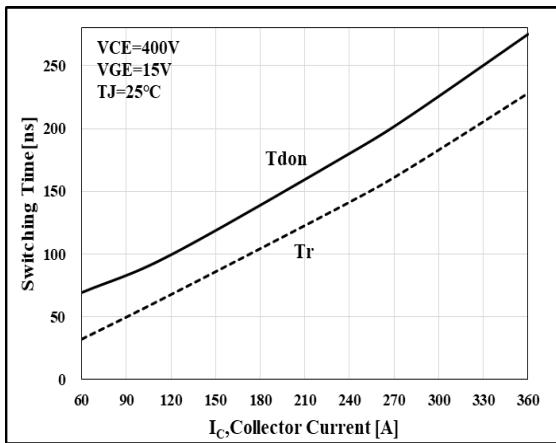


Figure 13.Switching Time-I<sub>c</sub> Characteristics

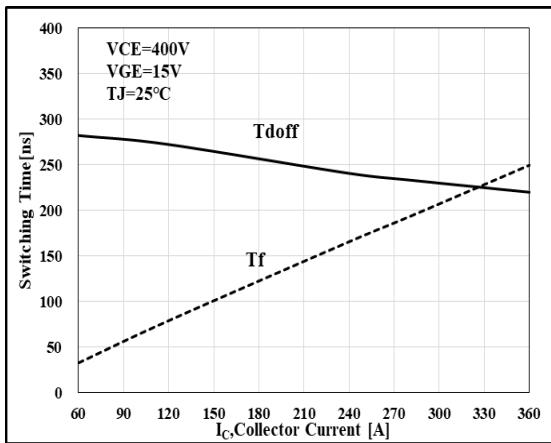


Figure 14.Switching Time-I<sub>c</sub> Characteristics

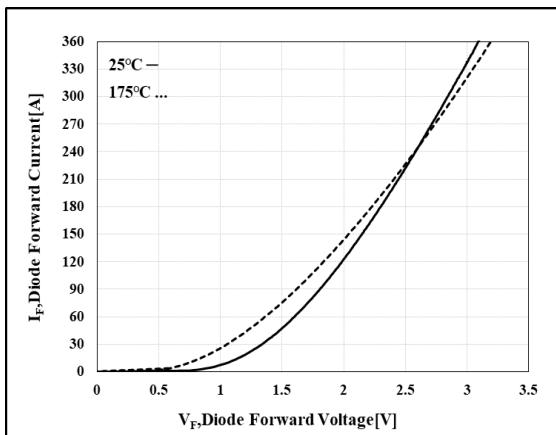


Figure 15.Diode Forward Characteristics

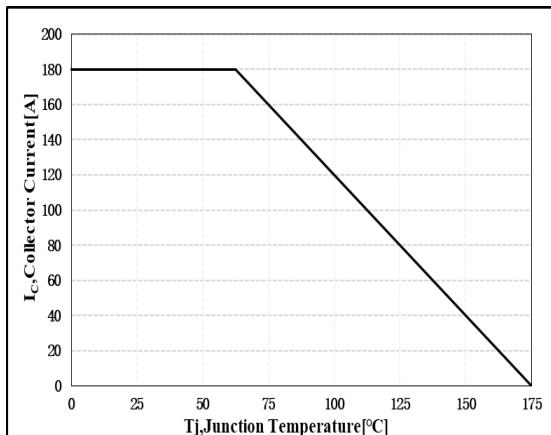


Figure 16.Collector Current-T<sub>j</sub> Characteristics

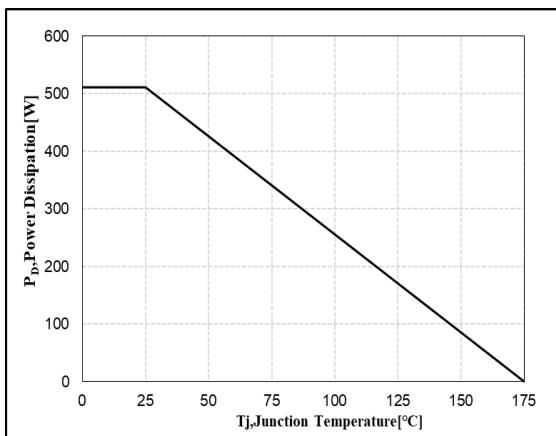


Figure 17.Power dissipation

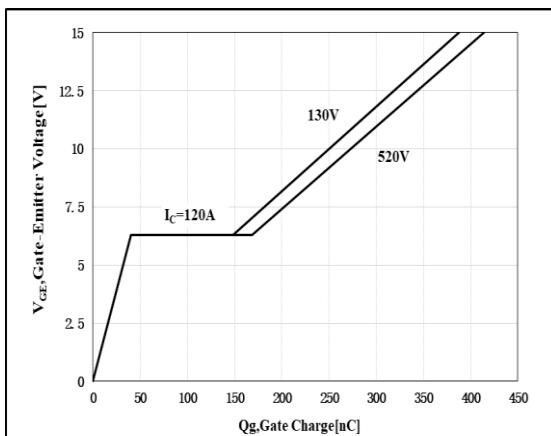


Figure 18.Gate Charge Characteristics

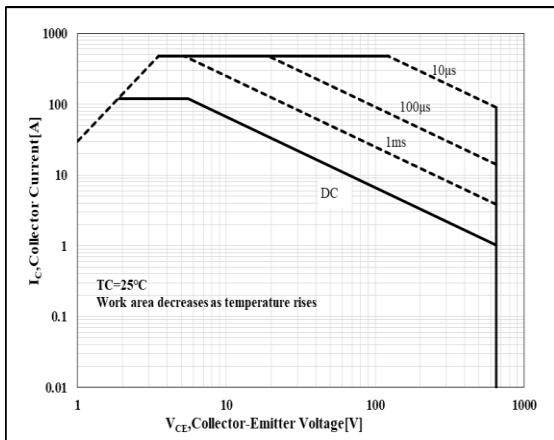


Figure 19. Forward Bias Safe Operating Area

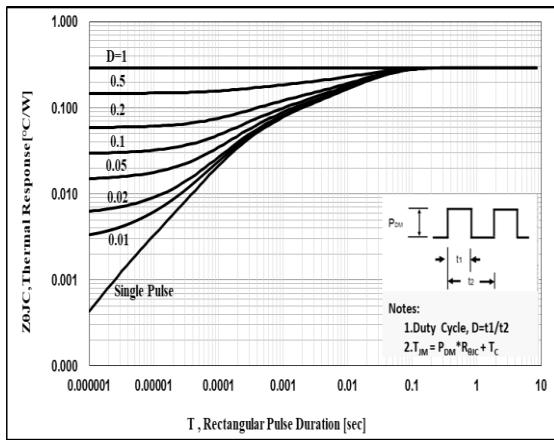
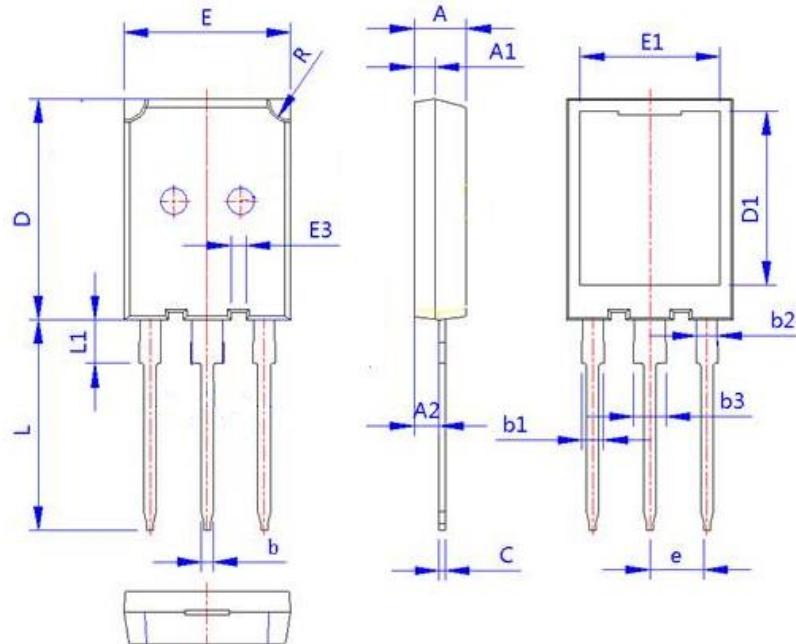


Figure 20. IGBT Transient Thermal Impedance

## Package Information



项 目	规范(mm)	
	MIN	MAX
A	4.85	5.15
A1	1.85	2.15
A2	2.15	2.65
b	1.07	1.33
b1	1.90	2.46
b2	1.90	2.16
b3	2.82	3.43
c	0.55	0.70
D	20.75	21.15
D1	16.20	16.90
E	15.50	16.10
E1	13.01	13.51
E3	1.25	1.65
e	5.44(BSC)	
R	1.80	2.20
L	19.60	20.40
L1	4.00	4.48

TO-247Plus Package

### The name and content of poisonous and harmful material in products

Part's Name Limit	Hazardous Substance									
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE	DIBP	DEHP	DBP	BBP
	≤0.1%	≤0.1%	≤0.01 %	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%
Lead Frame	○	○	○	○	○	○	○	○	○	○
Molding	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○	○	○	○	○
Solder	×	○	○	○	○	○	○	○	○	○
Note	○: Means the hazardous material is under the criterion of 2011/65/EU. ×: Means the hazardous material exceeds the criterion of 2011/65/EU. The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.									

### Warnings

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. IGBTs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Huajing Microelectronics and subject to regular change without notice.

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Modify :

Version	Modify record
2025V01	Initial release